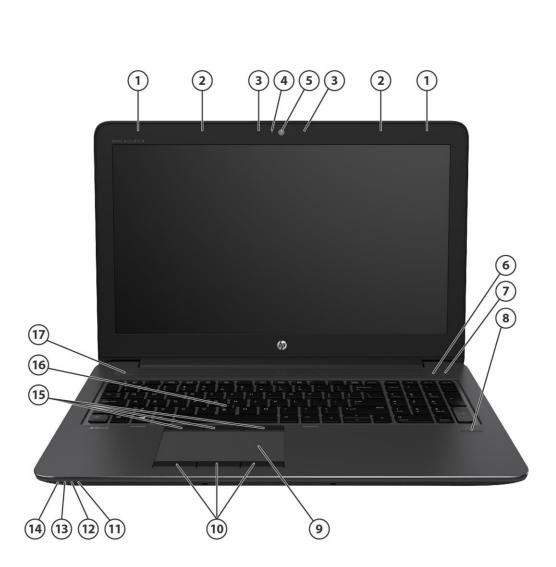
Overview

HP ZBook 15 G4 Mobile Workstation



FRONT VIEW

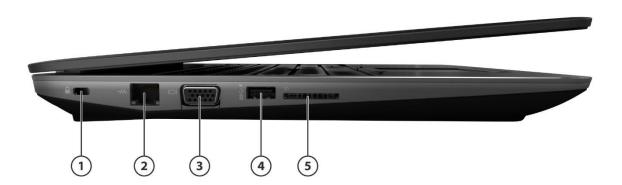
- 1. WLAN antennas (2)
- 2. WWAN antennas (optional)
- 3. Internal microphone
- 4. Webcam light (with webcam)
- 5. Webcam
- 6. Wireless button
- 7. Volume mute button
- 8. Fingerprint reader (select models only)

- 9. Touchpad with scroll zone
- 10. Lower right, center, left touchpad buttons
- 11. Storage light indicator
- 12. Battery light indicator
- 13. Power light indicator
- 14. Wireless light indicator
- 15. Upper Right, Center, Left Touchpad buttons
- 16. Pointstick
- 17. Power button



Overview

LEFT VIEW



- 1. Security cable slot
- 2. RJ-45 (Ethernet)
- 3. VGA port

- 4. USB 3.0 port (charging)
- 5. SD Card reader

RIGHT VIEW

- 1. Smart Card reader
- 2. Stereo microphone in / headphone-out combo jack
- 3. (2) USB 3.0 Ports
- 4. HDMI 1.4 port

- 5. (2) Thunderbolt[™] 3* ports
 - Power connector
 - Power LED



6.

7.

Overview

BOTTOM VIEW



1. Speakers



Overview

At A Glance

- Windows[®] 10 editions, or FreeDOS
- Mainstream full performance industrial design, Casted magnesium-reinforced chassis, top cover frame features soft touch paint with lightweight aluminum insert anodized in HP's new "Space Silver" color with chemical etching. Backlight keyboard in full aluminum deck with magnesium bottom reinforcement, chemically strengthened glass touchpad, and updated system functions indicators. HP Spill Resistant Keyboard with Durakeys, touchpad buttons with Duracoat finish. Diamond cut process showcased around keyboard deck.
- Designed to pass Mil-Std-810G tests.
- Workstation-caliber NVIDIA[®] Quadro[®] discrete graphics: NVIDIA[®] Quadro[®] M620 (2GB GDDR5), NVIDIA[®] Quadro[®] M1200 (4GB GDDR5), AMD RadeonPro[™] WX 4150 (4GB GDDR5), NVIDIA[®] Quadro[®] M2200 (4GB GDDR5); NVIDIA[®] Optimus or AMD Enduro[™] technology.
- Intel Integrated graphics: Intel[®] HD Graphics 530 integrated on Core™ i7. Intel[®] HD Graphics P530 on Xeon[®] processors.
- ISV certified to provide fast and reliable performance with workstation applications, including manipulation of 3D textures.
- Choice of 7th generation Intel[®] Core[™] i7 and i5 quad-core or Xeon[®] processors.
- Intel[®] Core[™] i7 with vPro, Intel Core[™] i5 with vPro technology or Intel Xeon[®] with vPro technology (optional)
- HP Performance Advisor for optimal configuration, compatibility and performance
- Up to four SODIMMs, for system memory up to 64 GB. ECC memory with Intel Xeon[®] processors.
- Supports multi-display, including up to four (4) displays without a docking solution, with hybrid graphics enabled. Supports up to six (6) displays with HP Zbook Dock with Thunderbolt[™] 3 (sold separately), with hybrid graphics enabled.
- Two (2) Thunderbolt[™] 3 ports (supporting DisplayPort 1.2, USB 3.1, PCIe Gen 3 devices) on the new USB-C[™] connector, for high speed data/video/audio transfer support.
- Bang and Olufsen audio optimized for high fidelity audio with immersive surround sound with deep, rich bass and crystal clear dialog without distortion at high volume
- Long life battery solution: 9-cell (90 WHr)
- 2 discrete buttons with LED indicator for convenient one touch access Wireless On/Off, Volume Mute
- Widescreen 15.6-inch diagonal anti-glare LED-backlit display: FHD (1920x1080) standard viewing angle, FHD (1920x1080) ultrawide viewing angle, or UHD (3840x2160) ultrawide viewing angle with HP DreamColor Technology, or FHD Touch (1920x1080) ultrawide viewing angle.
- Wireless connectivity options:
 - Intel[®] Dual Band Wireless-AC 8265 802.11 AC/a/b/g/n (2x2) WiFi and Bluetooth[®] 4.2 combo adaptor (vPro) or Intel[®] Dual Band Wireless-AC 8265 802.11 AC/a/b/g/n (2x2) WiFi and Bluetooth[®] 4.2 combo (non-vPro)
 - Optional integrated wireless 3G or 4G (LTE) mobile broadband module support
- Three dedicated drive slots. (2) M.2 slots and (1) 2.5" drive bays.
- Security features including HP Client Security Manager, managed via single console.
- Low halogen

•

• HP BIOS technology, including HP Sure Start to identify and recover from unknown BIOS attacks.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Features

OPERATING SYSTEM

Preinstalled	Windows® 10 Pro 64 ¹ Windows® 10 Home 64 ¹ Windows® 10 Home Single Language 64 ¹
Supported	FreeDOS 2.0 Windows [®] 10 Enterprise 64 ¹

Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately
purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10
is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over
time for updates. See http://www.microsoft.com

NOTE: In accordance with Microsoft's support policy, HP does not support the Windows[®] 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows[®] 8 or Windows 7 drivers on http://www.support.hp.com

PROCESSOR*

Intel® Xeon®E3-1535M v6 with Intel® HD graphics P630 (3.10 GHz, 2400 MHz, 8MB L3 cache, 4 Cores, 45W) Up to 4.20 GHz with Intel® Turbo Boost Technology

Intel® Xeon® E3-1505M v6 with Intel® HD graphics P630 (3.00 GHz, 2400 MHz, 8 MB L3 Cache, 4 Cores, 45W) Up to 4.00 GHz with Intel® Turbo Boost Technology

Intel[®] Core[™] i7-7820HQ with Intel[®] HD graphics 630 (2.90 GHz, 2400 MHz, 8 MB L3 Cache, 4 Cores, 45W) Up to 3.90 GHz with Intel[®] Turbo Boost Technology

Intel[®] Core[™] i7-7700HQ with Intel[®] HD graphics 630 (2.80 GHz, 2400 MHz, 6 MB L3 Cache, 4 Cores, 45W) Up to 3.80 GHz with Intel[®] Turbo Boost Technology

Intel[®] Core[™] i5-7440HQ with Intel[®] HD graphics 630 (2.80 GHz, 2400 MHz, 6 MB L3 Cache, 4 Cores, 45W) Up to 3.80 GHz with Intel[®] Turbo Boost Technology

Intel[®] Core[™] i5-7300HQ with Intel[®] HD graphics 630 (2.50 GHz, 2400 MHz, 6 MB L3 Cache, 4 Cores, 45W) Up to 3.50 GHz with Intel[®] Turbo Boost Technology

*Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

Also note that the Intel[®] Turbo Boost is based on max GHz for a single core.

CHIPSET

Mobile Intel[®] CM238



Features

INTEL® CORE™ I5 WITH VPRO/CORE I7 WITH VPRO/XEON® WITH VPRO TECHNOLOGY CAPABLE

Intel[®] Core[™] i5 with vPro[™], Core[™] i7 with vPro[™] and XEON[®] with vPro[™] technology is a selectable feature that is available on units configured with select processors, a qualified Intel[®] Centrino[®] WLAN module and a preinstalled Windows[®] operating system. It provides advances in remote manageability, security, energy efficient performance, and wireless connectivity. Intel[®] Active Management Technology (iAMT) offers built-in manageability and proactive security for networked mobile workstations, even when they are powered off* or when the operating system is inoperable. It can help identify threats before they reach the network, isolate infected systems, and update regardless of their power state.

* Requires a Windows operating system, network hardware and software, connection with a power source, and a direct (non-VPN) corporate network connection which is either cable or wireless LAN.

NOTE: Some functionality of Intel[®] Core[™] i5 with vPro[™]/Core[™] i7 with vPro[™]/Xeon[®] with vPro[™] technology, such as Intel[®] Active Management technology and Intel[®] Virtualization technology, requires additional third- party software in order to run. Availability of future "virtual appliances" applications for Intel[®] Core[™] i5 with vPro[™]/Core i7 with vPro[™]/XEON[®] with vPro[™] technology is dependent on third- party software providers. Compatibility with future "virtual appliances" is yet to be determined.

GRAPHICS

Intel Integrated

Intel[®] HD graphics 630¹; Intel[®] HD graphics P630¹;

NOTE 1: HD content required to view HD images.

NOTE 2: Available in hybrid graphics mode only with NVIDIA graphics

<u>Discrete</u>

AMD RadeonPro[™] WX 4150 with 4 GB dedicated GDDR5 video memory Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

NVIDIA[®] Quadro[®] M1200 with 4 GB dedicated GDDR5 video memory Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

NVIDIA[®] Quadro[®] M2200 with 4 GB dedicated GDDR5 video memory Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

NOTE: NVIDIA[®] Quadro[®] mobile professional graphics support up to four independent displays when using a HP ZBook Dock with Thunderbolt[™] 3 (sold separately) or DP 1.2 hubs with MST. AMD RadeonPro[™] professional graphics support up to six independent displays when using an HP ZBook Dock with Thunderbolt[™] 3 (sold separately) or DP 1.2 hubs with MST.

NVIDIA[®] Optimus Technology and AMD Enduro[™] Technology supported

NOTE 1: Color management on UHD DreamColor panels is not supported while NVIDIA® Optimus Technology is activated.



Features

DisplayPort 1.2 protocol features supported on Thunderbolt™ 3 ports:

- Legacy displays (HDMI, DVI, VGA) may be attached to Thunderbolt[™] port with the use of a certified dongle.
- DisplayPort monitors capable of supporting DisplayPort 1.2 may be directly attached to the Thunderbolt[™] port to achieve HBR2 with the use a dongle.
- DisplayPort monitors capable of supporting DP 1.2 may be directly attached to the Thunderbolt[™] port to achieve HBR2 with the use a dongle.
- Thunderbolt[™] 3 enabled monitors may be directly attached to the Thunderbolt[™] port to achieve HBR2 and MST.
- DisplayPort 1.2 MST feature ("daisy-chain" feature) is supported through Thunderbolt[™] 3 port on Thunderbolt[™] 3 enabled devices or DisplayPort 1.2 monitors (requires monitor with DisplayPort 1.2 MST capability) with the use of a dongle.
- Up to 2 streams (eight lanes) of DisplayPort 1.2 are supported over a single Thunderbolt[™] 3 port. Up to (2) 4K displays 24/30-bit color depth at 60 Hz or (1) 5K display supported over a single Thunderbolt[™] 3 port. (Requires Intel certified Thunderbolt[™] cable).
- DisplayPort 1.2 w/MST (Multi-stream Transport): Supports resolutions up to Full 4K, 24/30-bit color depth at 60 Hz, and WUXGA (1920 x1200) monitors, 24/30-bit color depth at 120 Hz.

*Thunderbolt[™] 3 is superset port supporting DisplayPort 1.2, USB 3.1 Gen 2, and PCIe Gen 3 devices over the new USB-C[™] connector. Install all the latest drivers for your Thunderbolt[™] device before connecting the device to the Thunderbolt[™] port. Thunderbolt[™] cable and Thunderbolt[™] device (sold separately) must be compatible with Windows. To determine whether your device is Thunderbolt[™] Certified for Windows, see https://Thunderbolttechnology.net/products.

Multi-Display Support

Without ZBook Dock with Thunderbolt[™] 3:

HP ZBook 15 with hybrid graphics and without the use of the ZBook dock supports up to a maximum of four independent displays. These four displays are the internal panel plus three external displays connected to the VGA and two of the three following ports: HDMI 1.4, Thunderbolt[™] 3, Thunderbolt[™] 3. HP ZBook 15 configuration with Intel integrated graphics and without the use of the ZBook dock supports up to a maximum of three independent displays. Any three display combination of the system panel, VGA, and two of the three following ports: HDMI, Thunderbolt[™] 3.

With ZBook Dock with Thunderbolt[™] 3:

The ZBook Dock with Thunderbolt[™] 3 dock has Thunderbolt[™] 3 port, VGA, and two DisplayPort 1.2. When used together with the HP ZBook 15 configuration with hybrid graphics, a maximum of 6 independent displays are supported. These six displays are internal panel, one external display connected to the system's VGA port and four external displays connected to the ZBook dock's Thunderbolt[™] 3, VGA, and two DisplayPort ports. When used together with the HP ZBook 15 configuration with Intel integrated graphics, a maximum of 3 independent displays are supported. Any three display combination of the system panel, system ports and ZBook Dock ports.

Without ZBook Dock with Thunderbolt™ 3 (using DP 1.2 MST)

Multi-stream Transport is a DP 1.2 feature that allows daisy chaining of DP 1.2 monitors that are Thunderbolt[™] 3 enabled (requires built in support of DP 1.2 MST in monitor), or the use of DP 1.2 hubs (Thunderbolt[™] 3 enabled) with MST to achieve 6 active displays without a docking station on configurations with hybrid graphics enabled.

* HP ZBook Dock with Thunderbolt[™] 3 sold separately.



Features

DISPLAY

Internal

15.6" diagonal LED backlit FHD UWVA IPS eDP anti-glare + PSR (Panel Self Refresh) (1920 x 1080);

15.6" diagonal LED backlit FHD SVA eDP anti-glare (1920 x 1080);

15.6" diagonal LED UHD UWVA IPS anti-glare DreamColor (3840 x 2160)

15.6" diagonal Touch LED-backlit FHD UWVA IPS (1920 x 1080)

External

Up to 30-bit (2^30) per pixel "Deep Color" (total of 1,073,741,824 color variations) **NOTE:** Resolutions are dependent upon monitor capability, and resolution and color depth settings.

STORAGE AND DRIVES

(1) 2.5" Storage Bay Drives*

1 TB 5400 rpm SATA 500 GB 7200 rpm SATA 500 GB SATA SSHD (Hybrid Drive) (8 GB cache) 500 GB 7200 rpm SATA SED (Self Encrypting Drive) 500 GB 5400 rpm SATA FIPS 140-2 SED Drive 256GB SATA SSD

(2) M.2 SATA SED Solid State DriveS*

256 GB SATA Self Encrypting Drive(SED) 512 GB SATA Self Encrypting Drive(SED)

HP 3D DriveGuard (Windows only)

The hard drive is mounted directly to the notebook frame, reducing the transmission of shock to the hard drive. Uses threeaxis digital motion detection with intelligent sensitivity to help protect the hard drive during normal use from shock and vibration. The digital accelerometer temporarily halts all data transfer and parks the hard drive when abrupt motion is detected.

HP Z Turbo Drives (NVMe PCIe SSD)

256GB PCIe (NVMe) TLC Solid State Drive 256GB PCIe (NVMe) MLC Solid State Drive 512GB PCIe (NVMe) MLC Solid State Drive 512GB PCIe (NVMe) TLC Opal 2 Solide State Drive 1TB PCIe (NVMe) MLC Solid State Drive

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.



Features

DRIVE CONTROLLERS

2.5" Storage Bays and M.2 Storage Bay (SATA): HP Z Turbo Drive: RAID: **NOTE:** Raid 0, 1 supported only on SATA drives. SATA-3 or SATA-2 for HDD and SATA-3 for SSD PCIe NVMe SSD 0, 1 supported*

MEMORY

Standard

64 GB DDR4 1.2V ECC or Non-ECC SDRAM (With transfer rates up to 2400MT/s¹) Four SODIMM slots supporting dual-channel memory 4 GB, 8GB and 16 GB SODIMMs (for Intel[®] Core[™] Processors) 8GB and 16 GB ECC SODIMMs (for Intel[®] XEON[®] Processors)

Maximum

Upgradeable to 65536 MB with optional 16384 MB SODIMMs in all 4 slots

Dual-channel

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory channels.

NOTE 1: Above 2 SODIMM Memories the transfer rates will down from 2400 MT/s to 2133 MT/s

NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed. Maximum memory capacities assume Windows 64-bit operating systems. With Windows 32-bit operating systems, memory above 3GB may not all be available due to systems

NETWORKING/COMMUNICATIONS

Communications*

Intel® I219-LM Gigabit* Network Connection (vPro configurations)

Wireless

Support for a broad range of secure, integrated wireless LAN and wireless WAN options featuring support for the latest industry standards. Optional Broadband Wireless (WWAN) requires a Windows[®] operating system and is available in select countries as a standard, factory configurable feature only. Integrated Bluetooth[®] is also available (factory configurable only) and can be combined with any of the supported wireless LAN and wireless WAN options.

802.11 Wireless LAN options**

Intel[®] Dual Band Wireless-AC 8265 802.11 a/b/g/n/ac (2x2) WiFi and Bluetooth[®] 4.2 combo (vPro) Intel[®] Dual Band Wireless-AC 8265 802.11 a/b/g/n/ac (2x2) WiFi and Bluetooth[®] 4.2 combo (non-vPro)

Wireless WAN - Mobile Broadband options***

HP lt4120 Qualcomm[®] Snapdragon[™] X5 LTE Mobile Broadband Module (optional)



Features

HP It4132, LTE/HSPA+ 4G Mobile Broadband Module (optional) HP hs3210 HSPA+ Mobile Broadband Module (optional)

*The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

**Wireless cards are optional or add-on features and requires separately purchased wireless access point and internet service. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

*** WWAN use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, and in all regions.



Features

AUDIO/MULTIMEDIA

Audio

Bang and Olufsen HD audio Integrated stereo speakers Integrated microphone (dual-microphone array when equipped with optional webcam) Button for volume mute; function keys for volume up and down Combo mic-in / stereo headphone-out jack

Webcam

Optional 720p HD webcam*

- HD format (widescreen)
- Supports videoconferencing and still image capture
- High quality fixed focus lens
- Video capture at various resolutions up to 1280x720 resolution (720p) and up to 30fps
- M-JPEG compression supports higher frame rates for video capture and videoconferencing
- Improved low light sensitivity
- Improved dynamic range

* HD content required to view HD images.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

Backlit keyboard with Function key control to toggle backlit brightness setting - off/full/half brightness The HP spill-resistant keyboard is designed using a thin layer of Mylar film under the keyboard and a drain system that funnels fluid through a hole in the bottom of the notebook. This minimizes the risk of damage to sensitive components underneath. The 100-key compatible keyboard features a full-pitch key layout with desktop keyboard features, such as editing keys, both left and right control and alt keys, function keys, and 18.7 x 18.4 mm key pitch (center-to-center spacing). U.S. and International key layouts are available. Other features include hot keys for instant access to power conservation and brightness.

Pointing Devices

Touchpad with On/Off button, two-way scroll, gestures, three pick buttons Pointstick with three additional pointstick buttons Image sensor touchpad for enhanced performance and improved precision on scroll and gesture

Buttons and Function Keys

Separate launch buttons provide easy access to the following features: wireless on/off, volume mute. Function keys provide control of the following features: standby mode, external display, volume down, volume up, and display brightness.



Features

SOFTWARE AND SECURITY

Preinstalled Software with Windows® Operating System

BIOS

HP BIOSphere Gen3¹ HP Sure Start Gen3² HP DriveLock | HP Automatic DriveLock BIOS Update via Network Master Boot Record Security Power On Authentication Secure Erase³ Absolute Persistence Module⁴ Pre-boot Authentication HP LAN-WLAN Protection

Multi Media

Cyberlink Power MediaPlayer CMIT

Communication / Connectivity

HP Mobile Connect Pro⁵ Native Miracast Support⁶ HP MAC Address Manager (select models only) HP Wireless Wakeup (select models only) HP SureConnect

HP Value Add Software

HP 3D DriveGuard 6 HP ePrint Driver + JetAdvantage⁷ HP Hotkey Support HP Recovery Manager HP Jumpstart HP Support Assistant¹² HP Noise Cancellation Software HP Performance Advisor HP Remote Graphics Software HP Velocity

Microsoft Products

Buy Office Bing Search Skype⁸

Manageability

HP Driver Packs⁹ HP SoftPaq Download Manager (SDM) HP System Software Manager (SSM)⁹ HP BIOS Config Utility (BCU)⁹ HP Client Catalog⁹ HP Manageability Integration Kit for Microsoft SCCM¹⁰ HP Image Assistant LANDESK Management¹¹

For more information on HP Client Management Solutions refer to: http://www.hp.com/go/clientmanagement.



Features

Client Security Software

- HP Client Security Suite Gen3¹³
- HP Security Manager (including Credential Manager and Password Manager)
- HP Fingerprint Sensor
- Power On Authentication
- Device Access Manager

Microsoft Defender ¹⁴ HP WorkWise¹⁵

Standard

For Windows 10, Trusted Platform Module (TPM) 2.0 (Infineon SLB9670). Common Criteria EAL4+ Certified.

HP Fingerprint Reader

For more information on HP Client Security Software Suite, refer to http://www.hp.com/go/clientsecurity.

- 1. Requires Intel[®] 7th generation processors
- 2. Available on HP Elite products equipped with Intel® 7th generation processors.
- 3. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88.
- 4. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
- 5. HP Mobile Connect Pro is only available on preconfigured devices with WWAN. For geographic availability refer to http://www.hp.com/go/mobileconnect
- 6. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast
- 7. Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see http://www.hp.com/go/eprintcenter). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.
- 8. Skype is not offered in China.
- 9. Not preinstalled, however available for download at http://www.hp.com/go/clientmanagement
- HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html
- 11. Subscription required.
- 12. Requires Windows and Internet Access
- 13. Requires Windows and Intel[®] 7th generation processors.
- 14. Opt in and internet connection required for updates
- 15. HP WorkWise smartphone app is available as a free download on the App Store and Google Play

Workstation ISV Certifications

See the latest list of certifications at: http://www.hp.com/go/isv

HP Remote Graphics Software



Features

The remote desktop solution for serious workstation users and their most demanding applications. Download at: http://www.hp.com/go/RGS

HP Performance Advisor

HP Performance Advisor enables optimal configuration of HP Mobile Workstations delivering stability and best performance. HP Performance Advisor will guide your system setup allowing a "custom" configuration that best matches the workstation to user requirements.

Download at: http://www.hp.com/go/performanceadvisor

Security

See Software section above.

Other Standard Security Features

Integrated Smart Card Reader One-Step Logon Security lock slot Support for Intel® AT

Optional Security Features

HP Fingerprint Sensor (optional)

Absolute Data Protect* with GPS Tracking - Subscription based security solution providing the ability to track, initiate physical recovery, conduct asset management, and perform remote data delete by utilizing GPS technology. GPS functionality requires HP Mobile Broadband Module.

* The Absolute Data Protect agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S.



Features

HP CENTRAL MANAGEMENT

HP offers a variety of scalable hardware, software, and BIOS-based security features to help you defend your organization against viruses and other threats. These integrated security features safeguard what matters to you the most - your data, device and identity. Now, be confident your fleet of devices is protected in multiple layers of HP Client Security protection.

HP BIOS Protection keeps you up and running with enhanced protection against virus attacks and other threats. And if the BIOS is accidently compromised, the auto recovery feature automatically restores it to its fully functional state.

HP Sure Start detects and negates a BIOS attack with automatic recovery of the BIOS even when the installation is accidentally compromised (i.e. power outage). When HP Sure Start heals the BIOS an event log is generated that an IT administrator can retrieve so the business is aware of a BIOS attack. Golden copy of BIOS is stored in protected nonvolatile memory providing redundant, hardware-based protection against a new generation of attacks. This helps to future-proof your technology and business.

An optional fingerprint reader and integrated Smart Card Reader help keep your identity secure. The security cable slot helps keep your notebook physically secure.

You can even permanently destroy data on your hard drive in preparation for your system disposal or redeployment with Secure Erase.



Features

POWER

Power Supply

HP 150W Slim Smart AC adapter (153 x 66 x 22 mm)

Primary Battery

HP Long Life 9-cell Polymer Battery (90 WHr) *

Battery Life

Battery life up to 17 hours 30 minutes (with 90Whr battery, FHD panel, Z Turbo Drive, Intel graphics)** Battery life up to 17 hours 26 minutes (with 90Whr battery, FHD panel, Z Turbo Drive; NVIDIA M1200, Hybrid graphics)**

System Standby Time

Up to TBD weeks***

* Available with 3-year limited warranty only

** Battery life will vary depending on the product model, configuration, loaded applications, features, use, wireless functionality and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See MobileMark14 battery benchmark https://bapco.com/products/mobilemark-2014/ for additional details.

*** Standby life will vary depending on various factors including battery, Memory, CPU, EC and LAN chip. The maximum capacity of the battery will naturally decrease with time and usage.

Power Conservation

NVIDIA[®] Optimus or AMD Enduro[™] technology Hibernation Standby ACPI compliance

ENVIRONMENTAL

US ENERGY STAR [®] IT ECO declaration EPEAT[®] registered* Low Halogen**

* EPEAT [®] registered where applicable. EPEAT registration varies by country. See www.epeat.net for registration status by country. See HP's 3rd party option store for solar energy accessory www.hp.com/go/options. **External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.

WEIGHTS & DIMENSIONS

Weight Starting at 5.7 lb. (2.60kg.)

Dimensions (w x d x h) 15.2 in x 10.4 in x 1.0 in



Features

386 mm x 264 mm x 26 mm

NOTE: Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components. Weight includes Quad Core CPU, FHD, Intel[®] HD graphics, 8GBx1 SODIMM, HP Z Turbo Drive, wLAN/BT, FPR, 9-cell battery, no wWAN.

PORTS/SLOTS

Ports Left side:

(1) RJ-45 (Ethernet) (1) VGA (1) USB 3.0 Charging Port (1) Security lock slot

Right side:

(1) HDMI 1.4
(2) Thunderbolt™ 3* (Supporting DisplayPort 1.2, USB 3.1 Gen2, PCIe Gen 3 devices)
(1) Stereo microphone in / headphone-out combo jack
(1) Power Connector
(2) USB 3.0

Thunderbolt™ 3

Thunderbolt[™]3 ports supports DisplayPort 1.2, USB 3.1 Gen 2, and PCIe Gen 3 devices over the new USB-C port connector. The port is compatible with existing DisplayPort displays, devices, and cables. Install all the latest drivers for your Thunderbolt[™] device before connecting the device to the Thunderbolt[™] port. Thunderbolt[™] cable and Thunderbolt[™] device (sold separately) must be compatible with Windows[®]. To determine whether your device is Thunderbolt[™] Certified for Windows, see https://thunderbolttechnology.net/products.

Digital Media Slots

(1) SD UHS-II Flash Media slot (Supports next generation SD (Secure Digital), backward compatible to SDHC, SDXC, (1) Integrated Smart Card Reader (Compatible with ISO 7816 compliant Smart Cards PC/SC interface support)

SERVICE AND SUPPORT

Limited 3-year or 1-year limited warranty options available, depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Optional* HP Care Pack Services are extended service contracts which go beyond your standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at http://www.hp.com/go/cpc.

*Sold separately or as an optional feature. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product. Consult your local HP Customer Support Center for details.



Technical Specifications – System Unit

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)	Nominal Operating Voltage	19.5 V	
	Average Operating Power	DreamColor	25W (Windows® 10 64-bit)
		Without DreamColor	16.8 W (Windows® 10 64-bit)
	Max Operating Power	< 150 W	
Temperature	Operating	32° to 95° F (0° to 35° C)	
	Non-operating	-4° to 140° F (-20° to 60° C)	
Relative Humidity	Operating	10% to 90%, non-condensing	
	Non-operating	5% to 95%, 101.6° F (38.7° C) maximum we	et bulb temperature
Shock	Operating	40 G, 2 ms, half-sine	
	Non-operating	200 G, 2 ms, half-sine	
Random Vibration	Operating	0.75 grms	
	Non-operating	1.50 grms	
Altitude (unpressurized)	Operating	-50 to 10,000 ft (-15.24 to 3,048 m)	
	Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)	
Industry Standard	UL	Yes	
Certifications	CSA	Yes	
	FCC Compliance	Yes	
	ENERGY STAR®	Select models*	
	EPEAT	Gold **	
	ICES	Planned	
	Australia /	Planned	
	NZ A-Tick Compliance		
	כככ	Planned	
	Japan VCCI Compliance	Planned	
	KC	Planned	
	BSMI	Planned	
	CE Marking Compliance	Planned	
	MIL STD 810G	Planned***	

* Configurations of the HP ZBook 15 G4 that are ENERGY STAR[®] qualified are identified as HP ZBook 15 G4 ENERGY STAR[®] on HP websites and on http://www.energystar.gov.

** EPEAT® registered where applicable. EPEAT registration varies by country. See http://www.epeat.net for registration status by country. See HP's 3rd party option store for solar energy accessory www.hp.com/go/options.

*** MIL STD 810G testing is pending and is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Damage under the MIL STD test conditions or any accidental damage requires an optional HP Accidental Damage Protection Care Pack. For accessibility information on HP products, please visit:

For accessibility information on HP products, please visit: http://www.hp.com/accessibility.



Technical Specifications - Displays

DISPLAYS

15.6" diagonal LED- backlit FHD UWVA IPS	Active Area (W × H)	13.54 x 7.59 in (34.4	x 19.4 cm)
	Dimensions (W × H)	15.6 in (39.6 cm)	
eDP anti-glare + Panel Self Refresh (PSR)	Weight	360 g (max)	
(1920 x 1080)	Surface Treatment	Anti-glare	
	Contrast Ratio	600:1 (typical)	
	Refresh Rate	60 Hz	
	Brightness*	300 nit typical	
	Pixel Resolution	Format	1920 x 1080 (FHD)
		Configuration	RGB Stripe
	Backlight	LED	
	PPI	141	
	Viewing Angle	85/85/85/85 (Left/R	ight/Down/Up) (typical)
		esent the typical specifica y vary either higher or lo	ations provided by HP's component manufacturers; wer."
15.6-inch diagonal LED	Active Area (W × H)	13.54 x 7.59 in (34.4	x 19.4 cm)
backlit FHD SVA eDP anti- glare + Panel Self	Dimensions (W x H)	15.6 in (39.6 cm)	
	Weight	380 g (max)	
Refresh (PSR) (1920 x 1080)	Surface Treatment	Anti-glare	
1000/		400:1 (turning)	

Surface Treatment	Anti-glare	
Contrast Ratio	400:1 (typical)	
Refresh Rate	60 Hz	
Brightness*	300 nit typical	
Pixel Resolution	Format	1920 X 1800 (FHD)
	Configuration	RGB Stripe
Backlight	LED	
PPI	141	
Viewing Angle	45/45/35/25 (Left/R	ight/Down/Up) (typical)
	esent the typical specific	ations provided by HP's component manufacturers;

actual performance may vary either higher or lower."

15.6-inch UHD UWVA IPS LED anti-glare + Panel Self Refresh (PSR) Dreamcolor (3840x2160)	Dimensions (W x H) Diagonal Size Weight Surface Treatment Contrast Ratio Refresh Rate Brightness*	13.62 x 7.59 in (3.6 x 15.6 in (39.6 cm) 345 g (max) Anti-glare 1000:1 (min) 60 Hz 270 nit typical	19.4 cm)
	Pixel Resolution Backlight	Pitch Format Configuration LED	0.090 x 0.090 mm 3840x2160 RGB Stripe



Technical Specifications - Displays

	PPI	282		
	Viewing Angle	85/85/85/85 (Left	:/Right/Down/Up) (typical)	
	* All specifications represent the typical specifications provided by HP's component m actual performance may vary either higher or lower."			
15.6-inch FHD TOUCH	Dimensions (W × H)	13.62 x 7.59 in (36	5 x 22.4 cm max)	
UWVA	Diagonal Size	15.6 in (39.6 cm)		
IPS LED (1920x1080)	Weight	345 g (max)		
(1920/1000)	Surface Treatment	Anti-glare		
	Contrast Ratio	600:1 (typ)		
	Refresh Rate	60 Hz		
	Brightness*	300 nit typ		
	Pixel Resolution	Format	1920 x 1080 (FHD)	
		Configuration	RGB Stripe	
	Backlight	LED		
	PPI	142		
	Viewing Angle	85/85/85/85 (Left	/Right/Down/Up) (typical)	
	* All specifications repre actual performance may		ications provided by HP's component manufacturers; ower."	



STORAGE AND DRIVES

Internal Storage				
1 TB 5400 rpm SATA Hard Drive	Drive Weight	0.21 lbs (94 g)- 0.21 lbs (95 g)	
	Capacity	1 TB		
	Height	0.28 in (7 mm)		
	Width	2.75 in (69.85 mm)		
	Interface	ATA-8, SATA 3.0		
	Transfer Rate	Synchronous (maximum) 600 MB/s		
	Seek Time	Single Track	2 ms	
	(typical reads, including	Average	12 ms-13 ms	
	settling)	Maximum	18 ms-22 ms	
	Cache	Up to 32MB		
	Rotational Speed	5400 rpm		
	Logical Blocks	1,953,525,168		
	Operating Temperature	32° to 140° F (0° to 60° C) [case temp]		
	Features	ATA Security, S.M.A.R.T., NCQ, Ultra DMA		
500 GB 7200 rpm SATA Hard Drive	Drive Weight	0.20 lbs (92 g) ~ 0.25 lbs (115 g)	
	Capacity	500 GB		
	Height	0.28 in (7 mm)		
	Width	2.75 in (69.85mm)		
	Interface	ATA-8, SATA 3.0		
	Transfer Rate	-	600 MB/s (Drive Capability)	
	Seek Time (typical reads, including	Single Track	1.5 ms ~ 2 ms	
	settling)	Average	11 ms ~ 13 ms	
	-	Maximum	18 ms ~ 22 ms	
	Cache	Up To 32 MB		
	Rotational Speed	7200 rpm		
	Logical Blocks	976,773,168	1	
	Operating Temperature	32° to 140° F (0° to 60° C)	•	
	Features	ATA Security, S.M.A.R.T., N	icų, uttra DMA	



500 GB Hybrid, 8 GB cache	Drive Weight	0.198 lbs (90 g) ~ 0.20 lbs 500 GB	(92 g)	
	Capacity			
	Height Width	0.28 in (7 mm)		
		2.75 in (69.85 mm)		
	Interface Transfor Pate	ATA-8, SATA 3.0		
	Transfer Rate	Synchronous (maximum)		
	Seek Time (typical reads, including	Single Track	1.5 ms ~ 2 ms	
	settling)	Average	12 ms ~13 ms	
	-	Maximum	22 ms ~ 32 ms	
	Cache	Up to 128MB		
	Rotational Speed	5400 rpm		
	Logical Blocks	976,773,168		
	Operating Temperature	32° to 140° F (0° to 60° C) [[case temp]	
	Features	ATA Security, S.M.A.R.T., N	CQ, Ultra DMA	
	Duine Weight	0.21 lbs (05-)		
500 GB 7200 rpm SATA SED FIPS* 140-2	Drive Weight	0.21 lbs (95g)		
compliant Hard Drive	Capacity	500 GB		
	Height	0.28 in (7 mm)		
	Width	2.75 in (69.85 mm)		
	Interface	ATA-8, SATA 3.0		
	Transfer Rate	-	600 MB/s (Drive Capability)	
	Seek Time	Single Track	1.5 ms	
	(typical reads, including settling)	Average	12 ms	
	Setting	Maximum	18-22 ms	
	Cache	32 GB		
	Rotational Speed	7200 rpm		
	Logical Blocks	976,773,168		
	Operating Temperature	32° to 140° F (0° to 60° C) [top cover temp]	
	Features	ATA Security; TCG Opal 2.x	, FIPS, S.M.A.R.T., NCQ, Ultra DMA	
	* FIPS-certified, hardware	-based AES-256 encryption	image.	
500 GB 7200 rpm SATA	Drive Weight	0.21 lbs (95g)		
Self Encrypting Drive	Capacity	500 GB		
	Height	0.28 in (7 mm)		
	Width	2.75 in (69.85 mm)		
	Interface	ATA-8, SATA 3.0		
	Transfer Rate	Synchronous (maximum)	600 MB/s (Drive Capability)	
	Seek Time	Single Track	2 ms	
	(typical reads, including	Average	12 ms	
	settling)	Maximum	18-22 ms	
	Cache	32 MB		
	Rotational Speed	7200 rpm		
	Logical Blocks	976,773,168		
	-			
	Operating remperature			
	Operating Temperature Features		00, S.M.A.R.T., NCQ, Ultra DMA	



256 GB M2 2280 SATA-3	Drive Weight	0.02 lb (<10 g)			
Self-Encrypting Drive (Opal 2) TLC Solid State Drive	Capacity	256 GB			
	Height	0.14 in (3.58 mm)- 0.09 in (2.23 mm)			
State Drive	Width	0.87 in (22 mm)			
	Interface	ATA-8, SATA 3.0			
	Performance	Maximum Sequential R	ead Maximum Sequential Write		
		Up to 530 MB/s	UP to 515 MB/s		
	Logical Blocks	500,118,192			
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
	Features	ATA Security; TCG Opal	2.0, DIPM; TRIM; DEVSLP		
512 GB M2 2280 SATA-3	Drive Weight	0.022 lb (<10 g)			
Self-Encrypting	Capacity	1TB			
Drive (Opal 2) TLC Solid	Height	0.14 in (3.7 mm			
State Drive	Width	0.87 in (22 mm)			
	Generation	XG4 NVMe			
	NAND Type	TLC			
	Form-Factor (I/O)	M.2 2280			
	Interface	PCIe GEN3X4			
	Performance	Maximum Sequential Read	Maximum Sequential Write		
		Up to 2400MB/s	Up to 1500MB/s		
	Logical Blocks	2,000,409,264			
	Operating Temperature	32° to 158°F (0° to 70°C	[ambient temp]		
	Features	ATA Security, L1.2			
HP Z Turbo Drive 512 GB,	Drive Weight	0.022 lb. (10 q)			
M.2 NVMe MLC Solid State	Capacity	512 GB			
Drive	Height	0.14 in (3.7 mm)			
	Width	0.87 in (22 mm)			
	Generation	SM951 NVMe			
	NAND Type	MLC			
	Form-Factor (I/O)	M.2 2280			
	Interface	PCIe NVMe Gen3X4			
	Performance	Maximum Sequential R	ead Maximum Sequential Write		
		Up to 3000 MB/s	Up to 1500 MB/s		
	Logical Blocks	1,000,215,216			
	Operating Temperature	32° to 158°F (0° to 70°C	[ambient temp]		
	Features	ATA Security (Option); T	-		



PerformanceMaximum Sequential ReadMaximum Sequential WriteUp to 3,100 MB/sUp to 1,400 MB/sLogical Blocks500,118,192Operating Temperature32° to 158°F (0° to 70°C) [ambient temp]FeaturesATA Security (Option);TRIM; L1.2
HP Z Turbo Drive 256 GB, Drive Weight0.022 lb (<10 g)
Drive Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Generation SM951 NVMe
NAND Type TLC
Form-Factor (I/O) M.2 2280
Interface PCIe GEN3X4
Performance Maximum Sequential Maximum Sequential Write Read
Up to 2260MB/s Up to 1260 MB/s
Logical Blocks 500,118,192
Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]
FeaturesATA Security (Option), TRIM; L1.2
HP Z Turbo Drive 512 GB, Drive Weight 0.022 lb (<10 g)
M.2 NVMe TLC Opal 2 Capacity 256 GB
Solid State Drive Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Generation SM951 NVMe
NAND Type TLC
Form-Factor (I/O) M.2 2280
Interface PCIe GEN3X4
Performance Maximum Sequential Maximum Sequential Write Read
Up to 2260MB/s Up to 1260 MB/s
Logical Blocks 500,118,192
Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]
FeaturesATA Security,TRIM; L1.2



HP Z Turbo Drive 1 TB, M.2 NVMe MLC Solid State Drive	Drive Weight Capacity Height Width Generation NAND Type Form-Factor (I/O) Interface	0.022 lb (<10 g) 256 GB 0.09 in (2.3 mm) 0.87 in (22 mm) SM951 NVMe MLC M.2 2280 PCIe GEN3X4	
	Performance	Maximum Sequential Read Up to 2260MB/s	Maximum Sequential Write Up to 1260 MB/s
	Logical Blocks Operating Temperature Features	500,118,192 32° to 158°F (0° to 70°C) ATA Security,TRIM; L1.2	[ambient temp]

*For hard drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) disk is reserved for system recovery software.



Technical Specifications - Security

SECURITY

HP Fingerprint Sensor	Mobile Voltage Operation	a 3.0V-3.6V Single Supply
	Operating Temperature	14° - 167°F (-10° - 75°C)
	Current consumption image	36mA
	Low latency wait for finger	950 uA
	Capture rate	3000 lines/sec
	ESD Resistance	IEC 6100-4-2 4B (+/-15KV)
	Detection Matrix	200*1 (plus another secondary line); 508 dpi, sensor area 12*3 mm

Technical Specifications – Networking

NETWORKING/COMMUNICATION

Intel® I219-LM Gigabit Network Connection (vPro configurations)	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13- 14) 100 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 802.3 Clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE(Energy Efficient Ethernet) Jumbo Frame 9K Auto MDI/MDIX Crossover cable detection
	Power	ACPI compliant - multiple power modes
	Management Performance	Energy Detect Low Power Mode(Green Ethernet)
	Features	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload(ARP & NS) Large send offload and Giant send offload Receiving Side Scaling MACSec Offload (802.3ae) Intel® vPro iSCSI Boot RSS is kernel based support (e.g. in Win Server 2013) Ultra Low Power at cable disconnect (<1mW) enables platform support for connected standby.
	Manageability	Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status
	Interface	PCI Express 1.1 x1 to fully support ASPM LOs/L1 and CLKREQ. NOTE: Intel [®] I219-LM Gigabit interface is not PCIe compliant. It operates at half of PCIe specification V1.1 (2.5GT/S) speed.
	NIC Device Driver Name	Intel® Ethernet Network Connection I219-LM

Intel® 1219-V Gigabit Network Connection (Non-vPro configurations)	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023. Clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE(Energy Efficient Ethernet) Jumbo Frame 9K Auto MDI/MDIX Crossover cable detection
	Power Management	ACPI compliant - multiple power modes Energy Detect Low Power Mode(Green Ethernet)
	Performance Features	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload(ARP & NS) Large send offload and Giant send offload Receiving Side Scaling MACSec Offload (802.3ae) Intel Non-vPro iSCSI Boot
	Manageability	Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status
	Interface	PCI Express 1.1 x1 to fully support ASPM LOs/L1 and CLKREQ. NOTE: Intel 82579 PCIe interface is not PCIe compliant. It operates at half of PCIe specification V1.1 (2.5GT/S) speed.
	NIC Device Driver Name	Intel 82579LM/82579V Ethernet Network Connection



HP lt4132 LTE/HSPA+ 4G Mobile Broadband Module

Technology/Operating bands	LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3) MHz, 850 (Band 5), 2600 (Band 7), 900 (Band 8) MHz, 800 (Band 20), 700 (Band 28) MHz. HSPA+: 2100 (Band 1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8) MHz
Wireless protocol standards	3GPP Release 10 LTE Specification CAT.4, 20MHz BW WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4 and MSC1 - MSC9
GPS	Standalone, A-GPS (MS-B and LTO)
GPS bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz
Maximum data rates	LTE: 150 Mbps (Download), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)
Maximum output power	LTE: 23 dBm HSPA+: 23.5 dBm E-GPRS 1900/1800: 26 dBm E-GPRS 900/850: 27 dBm GPRS 1900/1800: 29.5 dBm GPRS 900/850: 32.5 dBm
Maximum power consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average) E-GPRS: 2,600 mA (peak); 500 mA (average)
Form Factor	M.2, 3042-S3 Key B
Weight	6 g
Dimensions (Length x Width x Thickness)	42 x 30 x 2.3 mm

* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

HP hs3210 HSPA+ Mobile Broadband Module*

Technology/Operating bands	HSPA+: 2100 (Band1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 MHz (Band 5), 900 (Band 8) MHz	
Wireless protocol standards	WCDMA R99, 3GPP Release 5, 6 and 7 UMTS Specification E-GPRS: Class B, Multi-slot class 33, coding schemes CS1 - CS4 and MSC1 - MSC9	
Maximum data rates	HSPA+: 21.6 Mbps (Download), 5.76 Mbps (Upload)	
Maximum output power	E-GPRS: 296 kbps (Download), 236.8 kbps (Upload) GPRS: 107 kbps (Download), 85.6 kbps (Upload) HSPA+: 24 dBm E-GPRS 1800/1900: 26 dBm	
	E-GPRS 850/900: 27 dBm	



	GPRS 1800/1900: 30 dBm GPRS 850/900: 33 dBm
Maximum power consumption	HSPA+: 1,100 mA (peak); 800 mA (average) E-GPRS: 2,800 mA (peak); 700 mA (average)
Form Factor	M.2, 2242-S3 Key B
Weight	6 g
Dimensions (Length x Width x Thickness)	1.65 x 8.66 x 0.09 in (42 x 22 x 2.38 mm)

* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors.

HP lt4120 Qualcomm[®] Snapdragon™ X5 LTE Mobile Broadband Module

Wireless protocol standards3GPP Release 10 LTE Specification CAT.4, 20MHz BW WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification 1xEVD0 Release 0, A and B. E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4 and MSC1 - MSC9GPSStandalone, A-GPS (MS-A, MS-B and XTRA)GPSLTE: 150 Mbgs (Download), 50 Mbgs (Upload) DC-HSPA+: 42 Mbgs (Download), 5.76 Mbgs (Upload) DC-HSPA+: 42 Mbgs (Download), 5.76 Mbgs (Upload) EVD0 Rel.A: 3.1 Mbgs (Download), 5.76 Mbps (Upload) EVD0 Rel.A: 3.1 Mbps (Download), 5.4 Mbps (Upload) EVD0 Rel.A: 3.1 Mbps (Download), 5.4 Mbps (Upload) EVD0 Rel.B: 14.7 Mbps (Download), 5.4 Mbps (Upload) EVD0 Rel.B: 14.7 Mbps (Download), 5.4 Mbps (Upload) EVD0 Rel.B: 236.8 kbps (Download), 236.8 kbps (Upload) EVD0 Rel.B: 14.7 Mbps (Download), 5.6 kbps (Upload) EVD0 Rel.B: 14.7 Mbps (Download), 5.6 kbps (Upload) EVD0 Rel.B: 14.7 Mbps (Download), 5.6 kbps (Upload) EVD0 Rel.B: 14.7 Mbps (Download), 236.8 kbps (Upload) EVD0 RELB: 14.7 Mbps (Download), 236.8 kbps (Upload) E-GPRS 1900/1800: 25.6 dBm E-GPRS 1900/1800: 25.5 dBm GPRS 1900/1800: 29.5 dBm GPRS 1900/1800: 23.5 dBm E-GPRS: 2,800 mA	Technology/Operating bands	LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower), 800 (Band 20), 700 (Band 28). HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz EV-D0: 850 (BC0), 1900 (BC1) MHz (Only work with Verizon network) E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8) MHz
GPS bands1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHzMaximum data ratesLTE: 150 Mbps (Download), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) (DDA 1xRTT: 153.6 kbps (Download), 153.6 kbps (Upload) EVD0 Rel.A: 3.1 Mbps (Download), 153.6 kbps (Upload) EVD0 Rel.B: 14.7 Mbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 236.8 kbps (Upload) GPRS: 900/1800: 26 dBm E-GPRS 1900/1800: 29.5 dBm GPRS 1900/1800: 29.5 dBm GPRS 1900/1800: 29.5 dBm 		WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification 1xEVDO Release 0, A and B. E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4
Maximum data ratesLTE: 150 Mbps (Download), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21 Mbps (Download), 5.76 Mbps (Upload) (DMA 1xRTT: 153.6 kbps (Download), 153.6 kbps (Upload) EVD0 Rel.A: 3.1 Mbps (Download), 1.8 Mbps (Upload) EVD0 Rel.B: 14.7 Mbps (Download), 5.4Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) 	GPS	Standalone, A-GPS (MS-A, MS-B and XTRA)
DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload) CDMA 1xRTT: 153.6 kbps (Download), 153.6 kbps (Upload) EVD0 Rel.A: 3.1 Mbps (Download), 1.8 Mbps (Upload) EVD0 Rel.B: 14.7 Mbps (Download), 5.4Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload) GPRS: 85.6 kbps(Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 236.8 kbps (Upload)Maximum output power E-GPRS 1900/1800: 26 dBm E-GPRS 1900/1800: 29.5 dBm GPRS 1900/1800: 29.5 dBm GPRS 900/850: 32.5 dBmMaximum power consumptionLTE: 1,200 mA (peak); 900 mA (average) 1xRTT/EVD0: 1,000 mA (peak); 700 mA (average) 1xRTT/EVD0: 1,000 mA (peak); 500 mA (average) E-GPRS: 2,800 mA (peak); 500 mA (average) E-GPRS: 2,800 mA (peak); 500 mA (average)Form FactorM.2, 3042-S3 Key B	GPS bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz
HSPA+: 23.5 dBm 1xRTT/EVD0: 24dBm E-GPRS 1900/1800: 26 dBm E-GPRS 900/850: 27 dBm GPRS 1900/1800: 29.5 dBm GPRS 900/850: 32.5 dBm GPRS 900/850: 32.5 dBm LTE: 1,200 mA (peak); 900 mA (average) ronsumption HSPA+: 1,100 mA (peak); 800 mA (average) 1xRTT/EVD0: 1,000 mA (peak); 700 mA (average) E-GPRS: 2,800 mA (peak); 500 mA (average) Form Factor M.2, 3042-S3 Key B	Maximum data rates	DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload) CDMA 1xRTT: 153.6 kbps (Download), 153.6 kbps (Upload) EVDO Rel.A: 3.1 Mbps (Download), 1.8 Mbps (Upload) EVDO Rel.B: 14.7 Mbps (Download), 5.4Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload)
consumption HSPA+: 1,100 mA (peak); 800 mA (average) 1xRTT/EVD0: 1,000 mA (peak); 700 mA (average) E-GPRS: 2,800 mA (peak); 500 mA (average) Form Factor M.2, 3042-S3 Key B	Maximum output power	HSPA+: 23.5 dBm 1xRTT/EVDO: 24dBm E-GPRS 1900/1800: 26 dBm E-GPRS 900/850: 27 dBm GPRS 1900/1800: 29.5 dBm
Form Factor M.2, 3042-S3 Key B	-	HSPA+: 1,100 mA (peak); 800 mA (average) 1xRTT/EVD0: 1,000 mA (peak); 700 mA (average)
Weight 6.2 g	Form Factor	
	Weight	6.2 g



Technical Specifications – Networking

Dimensions42 x 30 x 2.3 mm(Length x Width xThickness)

Intel® Dual Band Wireless-AC 8265 802.11 AC/a/b/g/n (2x2) WiFi + Bluetooth® 4.2 Combo Adaptor* (vPro)	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11n	
	Interoperability	Wi-Fi certified	
	Frequency Band	802.11b/g/n	2.402 - 2.482 GHz Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels
		802.11a	4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz Note: Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)
	Data Rates	 802.11b: 1, 2, 9 802.11g: 6, 9, 9 802.11n: MCS (10) 	12, 18, 24, 36, 48, 54 Mbps 5.5, 11 Mbps 12, 18, 24, 36, 48, 54 Mbps 0 ~ MCS 15, (20MHz, and 40MHz) 50 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and
	Modulation	Direct Sequence Sprea CCK, BPSK, QPSK, 16-Q	d Spectrum JAM, 64-QAM, 256-QAM
	Security ¹	a/b/g mode of AES-CCMP: 12 802.1x auther WPA, WPA2: 8 WPA2 certifica IEEE 802.11i	8 bit in hardware ntication 102.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access	Point Required)
	Roaming	IEEE 802.11 compliant	roaming between band Access Points
	Output Power ²	 802.11g:+14 802.11a:+14 802.11n HT20 	dBm minimum dBm minimum dBm minimum)(2.4GHz) : +13dBm minimum)(2.4GHz) : +13dBm minimum



Technical Specifications – Networking

		20(5GHz) : +12dBm minimum	
Power Consumption	 802.11n HT40(5GHz) : +12dBm minimum Transmit: 2.0 Watts (max) Receive: 1.6 Watts (max) Idle mode (PSP): 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated) Connect Standby: 10mW (WLAN + BT) Radio disabled: 5 mW 		
Power Management	ACPI and PCI Express 802.11 compliant pov	compliant power management wer saving mode	
Receiver Sensitivity ³	802.11b, 1Mbps : -94dBm maximum 802.11b, 11Mbps : -86dBm maximum 802.11g, 6Mbps : -88dBm maximum 802.11g, 54Mbps : -74dBm maximum 802.11a, 6Mbps : -88dBm maximum 802.11a, 54Mbps : -74dBm maximum 802.11n, MCS07 : -69dBm maximum 802.11n, MCS15 : -66dBm maximum 802.11ac, 1SS, MCS-0 : -86dBm maximum 802.11ac, 2SS, MCS-0 : -83dBm maximum 802.11ac, 2SS, MCS-9 : -58dBm maximum		
Antenna Type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO and Bluetooth communications		
Form Factor	PCI-Express M.2 MiniCard		
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm Or Type 1630 : 2.3 x 16.0 x 30.0 mm		
Weight	Type 2230 : 2.8g Or Type 1630 : 2g		
Operating Voltage	3.3v +/- 9%		
Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating Non- operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
LED Activity	LED Amber – Radio OFF; LED White – Radio ON		



Technical Specifications – Networking

Bluetooth® Specification	4.2 Compliant			
Frequency Band	2402 to 2480 MHz			
Number of Available Channels				
Data Rates and Throughput	Legacy: 3 Mbps c	lata rate; throu	ghput up to 2.1	7 Mbps
	BLE: 1 Mbps data	a rate; throughp	ut up to 0.2 Mb	ops
	Legacy: Synchron voice channels	nous Connectio	n Oriented link	s up to 3, 64 kbps,
				•
Transmit Power		•	•	
Receiver Sensitivity	Modulation	0.01% BER	0.001% BER]
2	GFSK	-80 dBm	-70 dBm	
	π/4-DQPSK	-80 dBm	-70 dBm	
	8DPSK	-80 dBm	-70 dBm	
Power Consumption	Peak (Rx) 230 m	W		
Antenna	Internally integra	ated within mod	lule	
Range				
Electrical Interface	USB 2.0 complia	nt		
Bluetooth® Software Supported	Microsoft Windo	ws Bluetooth So	oftware	
Link Topology	Point to Point, M	ultipoint Pico N	ets up to 7 slav	/es
Security	Full support of B	luetooth Securi	ty Provisions	
Power Management Certifications	Microsoft Windo	ws ACPI, and US	B Bus Support	
	-			
Security	All necessary reg including:	gulatory approv	als for support	ed countries,
	FCC (47 CFR) Par	t 15C, Section 1	5.247 & 15.249	9
Power management certificactions	Low Voltage Dire	ective IEC950		
Certifications Bluetooth® Profiles Supported	Serial Port Profil Service Discover Dial-Up Network Generic Object Ex Object Push Prof Hard Copy Cable Personal Area Ne Human Interface Hands Free Profi Advanced Audio	e (SPP)1 y Application Pr ing (DUN)1,2 xchange Profile ile (OPP)1,2 Replacement (H etworking Profil Device Profile (le (HFP) Distribution Pro	(GOEP)1,2 HCRP)1,2 e (PAN)1,2 (HID)1,2 file (A2DP)	
	Frequency Band Number of Available Channels Data Rates and Throughput Transmit Power Receiver Sensitivity Power Consumption Antenna Range Electrical Interface Bluetooth® Software Supported Link Topology Security Power Management Certifications Securitys	Frequency Band2402 to 2480 MiNumber of Available ChannelsLegacy: 0~79 (1BLE: 0~39 (2 MH)BLE: 0~39 (2 MH)Data Rates and ThroughputLegacy: 3 Mbps ofBLE: 1 Mbps dataLegacy: Synchrovoice channelsLegacy: SynchroVoice channelsLegacy: AsynchroVoice channelsLegacy: AsynchroKbps asymmetridThe Bluetooth ofTransmit PowerThe Bluetooth ofReceiver SensitivityModulationGFSKn/4-DQPSKBDPSKPower ConsumptionPeak (Tx) 330 mlPeak (Rx) 230 mlSelective SusperAntennaInternally integraRangeLegacy Up to 33Bluetooth® Software SupportedMicrosoft WindoLink TopologyPoint to Point, MSecurityFull support of BPower ManagementSelf-configurablCertificationsSelf-configurablBluetooth® Profiles SupportedService DiscoverBluetooth® Profiles SupportedService DiscoverBluetooth® Profiles SupportedService DiscoverDial-Up NetworkGeneric Object EObject Push ProfilesPersonal Area NetBluetooth® Profiles SupportedService DiscoverNuman InterfaceHands Free ProfiAdvanced AudioHands Free Profi	Frequency Band2402 to 2480 MHzNumber of Available ChannelsLegacy: 0-79 (1 MHz/CH) BLE: 0-39 (2 MHz/CH)Data Rates and ThroughputLegacy: 3 Mbps data rate; through Legacy: Synchronous Connection voice channelsData Rates and ThroughputLegacy: Synchronous Connection voice channelsLegacy: Synchronous Connection voice channelsLegacy: Synchronous Connection voice channelsTransmit PowerThe Bluetooth component shall device with a maximum transmit Receiver SensitivityModulation O.01% BER GFSK -80 dBmPower ConsumptionPeak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mWAntennaInternally integrated within moor RangeBluetooth® Software Supported Link TopologyMicrosoft Windows Bluetooth Security Point to Point, Multipoint Pico N SecuritySecurityFull support of Bluetooth Security modes, including Standby, Hold, SecurityPower management certificationsSecif-configurable to optimize por modes, including Standby, Hold, Service Discovery Application Pro Dial-Up Networking (DUN)1.2 Generic Object Exchange Profile Object Push Profile (SPP)1Bluetooth® Profiles SupportedSerial Port Profile (SPP)1 Service Discovery Application Pro Dial-Up Networking (DUN)1.2 Generic Object Exchange Profile Upak Profile Object Push Profile (HFP) Advanced Audio Distribution Profile Hands Free Profile (HFP) Advanced Audio Distribution Profile Hands Free Profile (HFP) Advanced Audio Distribution Profile	Frequency Band2402 to 2480 MHzNumber of Available ChannelsLegacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)Data Rates and ThroughputLegacy: 3 Mbps data rate; throughput up to 0.2 M Legacy: Synchronous Connection Oriented link voice channelsData Rates and ThroughputLegacy: Synchronous Connection Oriented link voice channelsLegacy: Synchronous Connection Less links 2 kbps asymmetric (3-DH5) or 864 kbps symmetric device with a maximum transmit power of +40Transmit PowerThe Bluetooth component shall operate as a CI device with a maximum transmit power of +40Receiver SensitivityModulation0.01% BER ORBMPower ConsumptionPeak (TX) 330 mW Peak (TX) 330 mW Peak (TX) 330 mW Peak (TX) 230 mW Selective Suspend 17 mWAntennaInternally integrated within moduleRangeLegacy Up to 33 ft (10 m) BLE Up to 99 ft (30 m)Electrical InterfaceUSB 2.0 compliantBluetooth® Software Supported Microsoft Windows Bluetooth SoftwareMicrosoft Windows ACPI, and USB Bus Support CertificationsSelf-configurable to optimize power conservat modes, including: Standby, Hold, Park, and Snif SecurityPower management certificationsETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE MarkCertificationsSerial Port Profile (SDP)1 Service Discovery Application Profile (SDP)1



Bluetooth® V4.2 support feature

V4.2: ESR8 compliant, LE Secure Connection – Basic.

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.

Intel® Dual Band Wireless-AC 8265 802.11 AC/a/b/g/n (2x2) WiFi + Bluetooth® 4.2 Combo Adaptor* (non-vPro)	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac	
	Interoperability	Wi-Fi certified	
	Frequency Band	802.11b/g/n	
		2.402 - 2.482 GHz Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels	
		802.11a	
		 4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz Note: Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161) 	
	Antenna Structure	2 transmit; 2 receive (2x2)	
	Data Rates	802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: card will support rates for NSS=1 and NSS=2 for RX and TX for 20 and 40 MHz channels. Short and long guard interval shall be supported. 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)	
	Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM	
	Security ¹	 IEEE and Wi-Fi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication 	



	 WPA2 certif IEEE 802.11 		
Network Architecture Models Roaming Output Power ²	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) IEEE 802.11 compliant roaming between access points • 802.11b : +16dBm minimum • 802.11g : +14dBm minimum • 802.11a : +14dBm minimum • 802.11n HT20(2.4GHz) : +13dBm minimum • 802.11n HT40(2.4GHz) : +13dBm minimum • 802.11n HT20(5GHz) : +12dBm minimum • 802.11n HT40(5GHz) : +12dBm minimum • 802.11ac 80MHz(5GHz) : +11dBm minimum		
Power Consumption	Transmit: 2.0 W (max) Receive: 1.6 W (max) Idle mode (PSP): 180 mW (WLAN Associated) Idle mode: 60 mW (WLAN unassociated) Radio disabled: 30 mW		
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode		
Receiver Sensitivity ³	802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), - 85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)		
	802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps) 88 dBm (11 Mbps)		
	802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), - 85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)		
	802.11n:-69 dBm (1	50 Mbps), -66 dBm (300 Mbps)	
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications		
Form Factor	PCI-Express Half-MiniCard		
Dimensions	0.134 x 1.06 x 1.18 in (3.4 x 26.8 x 30 mm)		
Weight	3.1g		
Operating Voltage	3.3v +/- 9%		
Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	



Operating Non-operating

0 to 10,000 ft. (3,048 m) 0 to 50,000 ft. (15,240 m)

LED Activity

LED Amber - Radio OFF; LED White - Radio ON

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth® 4.2 Wireless Technology	
Bluetooth Specification	4.0+EDR Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	79 (1 MHz) available channels
Data Rates and Throughput	3 Mbps data rate; throughput up to 2.17 Mbps
	Synchronous Connection Oriented links up to 3, 64 kbps, voice channels
	Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or 1306.9 kbps symmetric
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of +4 dBm for BR and EDR
Receiver Sensitivity	Better than -20 dBM at 0.1 % raw bit error rate
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW
Antenna	Internally integrated within module
Range	Up to 33 ft. (10 m)
Electrical Interface	USB 2.0 compliant
	Microsoft Windows Plug and Play compliant
Bluetooth [®] Software	Broadcom Bluetooth for Windows
Supported	Microsoft Windows Bluetooth Software
Link Topology	Point to Point, Multipoint Pico Nets up to 7 slaves
Security	Full support of Bluetooth Security Provisions
Power Management	Microsoft Windows ACPI, and USB Bus Support
	Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff
Certifications	All necessary regulatory approvals for supported countries, including:
	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
	ETS 300 328, ETS 300 826
	Low Voltage Directive IEC950
	UL, CSA, and CE Mark
Bluetooth [®] Profiles Supported	Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2}

HP Integrated Module with Bluetooth® 4.2 Wireless Technology



Technical Specifications – Networking

Human Interface Device Profile (HID)^{1,2} FAX Profile (FAX) Basic Imaging Profile (BIP)² Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)

1. Indicates the profile is supported by Microsoft Windows XP SP2

2. Indicates the profile is part of Windows Vista

* Wireless access point and internet service required. Availability of public wireless access points limited.

Intel® Dual Band Wireless- AC 3168 802.11 ac (1x1) WiFi and Bluetooth® 4.2 Combo Adapter (non-vPro)	Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac
	Interoperability	Wi-Fi certified
	Frequency Band	802.11b/g/n • 2.402 – 2.482 GHz
		Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
		802.11a/n • 4.9 – 4.95 GHz (Japan) • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz
		Note: Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)
	Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) 802.11ac : MCS0 ~ MCS7, (1SS) (20MHz, 40MHz, and 80MHz)
	Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
	Security ¹	 IEEE and Wi-Fi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through CCX4 and CCX Lite WAPI



Technical Specifications – Networking

Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)		
Roaming	IEEE 802.11 compliant roaming between access points		
Output Power ²	 802.11b : +16dBm minimum 802.11g : +14dBm minimum 802.11a : +14dBm minimum 802.11n HT20(2.4GHz) : +13dBm minimum 802.11n HT40(2.4GHz) : +13dBm minimum 802.11n HT20(5GHz) : +12dBm minimum 802.11n HT40(5GHz) : +12dBm minimum 802.11ac 80MHz(5GHz) : +11dBm minimum 		
Power Consumption	Receive: 1.6 W (Idle mode (PSP): 1	80 mW (WLAN Associated) W (WLAN unassociated)	
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode		
Receiver Sensitivity ³	802.11b, 1Mbps : -94dBm maximum 802.11b, 11Mbps : -86dBm maximum 802.11g, 6Mbps : -88dBm maximum 802.11g, 54Mbps : -74dBm maximum 802.11a, 6Mbps : -86dBm maximum 802.11a, 54Mbps : -72dBm maximum 802.11n, MCS07 : -69dBm maximum 802.11n, MCS15 : -66dBm maximum 802.11ac, 1SS, MCS-0 : -86dBm maximum 802.11ac, 1SS, MCS-9 : -61dBm maximum 802.11ac, 2SS, MCS-9 : -58dBm maximum 802.11ac, 2SS, MCS-9 : -58dBm maximum		
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications		
Form Factor	PCI-Express M.2 MiniCard		
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm Or Type 1630 : 2.3 x 16.0 x 30.0 mm		
Weight	Type 2230 : 2.8g Or Type 1630 : 2g		
Operating Voltage	3.3v +/- 9%		
Temperature	Operating Non-operating	14° to 158° F (-10° to 70° C) 40° to 176° F (-40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	

Near Field Communications (NFC)

Controller

HP Module with NXP NFC Controller NPC100



Technical Specifications – Networking

Supports	 Windows 8, Proximity Events Windows 7, PC/SC NFC Forum Compliant Near Field Communications Controller 			
Dimensions (L × W × H)	Module 25 mm by	10 mm by 2.0 mm		
Chipset	NPC100			
System interface	12C			
NFC RF standards		4443 A ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092 Target and Initiator ECMA-320 NFCIP-2		
NFC Forum Support Tag	Туре 1, Туре 2, Тур	e3 and Type 4, NFCIP-1 and NFCIP-2		
Reader		ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 MIFARE RE DESFire FeliCa Jewel and Topaz cards		
Card Emulation	(PICC-VICC)			
Mode ¹	ISO/IEC 14443 A ISO	D/IEC 14443 B and B' MIFARE FeliCa		
Frequency	13.56 MHz			
NFC Modes Supported	Reader/Writer, Peer-to-Peer			
Raw RF Data Rates	106, 212, 424, 848	106, 212, 424, 848 kbps		
Operating temperature	0°C to 70°C			
Storage temperature	-20°C to 125°C	-20°C to 125°C		
Humidity	10-90% operating 5-95% non-operating			
Supply Operating voltage	2.97 to 5.5 Volts			
I/O Voltage	1.8V or 3.3V			
Power Consumption	Booster enable,	VBAT= 3.3V,		
	VCC_BOOST = 5V) Mode Power Consumption,	Typical ² Polling 7.3 mA Detected Test Tag Type 1 Total 283.8 mA Net Module 236.8 mA Detected Test Tag Type 2 Total 288.8 mA Net Module 241.8 mA Detected Test Tag Type 3 Total 287.7 mA Net Module 240.7 mA Detected Test Tag Type 4 Total 282.3 mA Net Module 235.3 mA		
Antenna connector Notes	 With applie Actual Pov 	nector FPC. Antenna matching is external to module. cation or UICC support ver Consumption is dependent on NFC antenna and circuit and on the particular polling sequence and period I.		

Technical Specifications - Audio and Multimedia

AUDIO/MULTIMEDIA – BANG & OLUFSEN

tion Key me Controls Duplex ophone In phone/Line Out rated Microphone	Volume up, volume down, and mute Yes Stereo Stereo
phone In phone/Line Out	Stereo Stereo
phone/Line Out	Stereo
-	
rated Microphone	Vec. dual digital microphone array when equipped with eptional webcam
	Yes, dual digital microphone array when equipped with optional webcam
uency Response	20 Hz - 20 kHz
al to Noise Ratio	106dB (DAC), 102dB (ADC)
l Harmonic ortion	91dB THD+n on LineOut/HP (0.003%)
e Floor	-110 dB
Sampling Rate(s)	Up to 192kHz
rd Sampling Rate(s)	Up to 96kHz
	16, 20 or 24-bit
	16, 20 or 24-bit
er Rating	2 Watts
edance	4 ohms
	al to Noise Ratio I Harmonic ortion e Floor Sampling Rate(s) rd Sampling Rate(s)

Technical Specifications - Power

POWER

HP 150W Slim Smart AC Adapter	Dimensions Weight Input	6.02 x 2.60 x .87 in (153 x 66 x 22 mm) 0.70 lbs (320 g) 100 to 240 VAC		
	mpat	Input Efficiency	88% min at 115 VAC	
		Input frequency range	47 to 63 Hz	
		Input AC current	2.9 A at 90 VAC, 1.45 A at 180 VAC	
	Output	Output power	150W	
	•	DC output	19.5V	
		Hold-up time	5 msec at 115 VAC input	
		Output current limit	<16A, Over voltage protection- 29V max automatic shutdown	
	Connector	3 pin/grounded, mates wit	th interchangeable cords	
	Environmental Design	Operating temperature	32° to 104° F (0° to 40° C)	
		Non-operating (storage) temperature	-4° to 149° F (-20° to 65° C)	
		Altitude	0 to 10,000 ft (0 to 3,048 m)	
		Humidity	20% to 80%	
		Storage Humidity	10% to 90%	
	Certifications	standards- IEC950, EN60950, UL1950, Class 1, SELV; Agency approvals- C- UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCIB, NOM-1 NYCE; MTBF- over 200,000 hours at 25°C ambient condition.		
HP Long Life 9-cell	Dimensions (H × W × L)	0.47 x 4.33 x 10.2 in (1.2 x	(11 x 26cm)	
Polymer Battery (90	Weight (max)	1.12lb (420g)		
WHr)	Cells/Type	9-cell; Polymer		
	Energy	Voltage	11.4V	
		Amp-hour capacity	7.905Ah	
		Watt-hour capacity	90Wh	
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)	
		Operating (Discharging)	14° to 140° F (-10° to 60° C)	
		Non-operating	-4° to 140° F (-20° to 60° C)	
	Battery Re-Charge Time	System in OFF or Standby Mode	3 hours	
		System ON	3 to 5 hours	
	Fuel Gauge LED	No		
	Warranty*	3 year		
	Compatible with optiona Travel Battery			
	* 3-year platform warranty is required for a 3-year Long Life Battery warranty.			



ENVIRONMENTAL DATA

Eco-Label Certifications & declarations	 This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: IT ECO declaration US ENERGY STAR[®] US Federal Energy Management Program (FEMP) EPEAT[®] GOLD registered in the United States. See http://www.epeat.net for registration status in your country. 		
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".		
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Sort idle)	11.20 W	10.51 W	11.24 W

Normal Operation (Long idle)	6.70 W	6.30 W	6.37 W
Sleep	1.13 W	1.12 W	1.14 W
Off	0.41 W	0.43 W	0.42 W

Note:

Energy efficiency data listed is for an ENERGY STAR[®] compliant product if offered within the model family. HP computers marked with the ENERGY STAR[®] Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR[®] specifications for computers. If a model family does not offer ENERGY STAR[®] compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows[®] operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	38 BTU/hr	36 BTU/hr	38 BTU/hr
Normal Operation (Long idle)	23 BTU/hr	22 BTU/hr	22 BTU/hr
Sleep	4 BTU/hr	4 BTU/hr	4 BTU/hr
Off	1.4 BTU/hr	1 BTU/hr	1 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions	Sound Power	Sound Pressure
(in accordance with	(L _{WAd} , bels)	(L _{pAm} , decibels)
ISO 7779 and ISO 9296)		
Typically Configured – Idle	3.2	22
Fixed Disk – Random writes	3.2	21
Longevity and Upgrading	This product can be upgraded, possibly extending	g its useful life by several years. Upgra

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 3 USB ports
- 2 Thunderbolt[™] 3 ports
- 1 2.5" Storage Bay Drive
- 2 M.2 SATA SED Solid State Drives



	 1 Smart Car 4 SODIMM n 1 HDMI 1.4 	nemory slots			
	Spare parts are of production.	e available throughout the warranty period and or for up	to "5" years after the end		
Batteries	This battery(s)	in this product comply with EU Directive 2006/66/EC			
	Mercury gr	in the product do not contain: reater the1ppm by weight greater than 20ppm by weight			
	Battery type: L	R2032 (coin cell) .ithium 5-cell high capacity Lithium-Ion battery (optional 8 cell av	vailable)		
Additional Information	direct This H Equip This p Drinki This p www. Plasti and IS This p	product is in compliance with the Restrictions of Hazardou ive – 2011/65/EC. IP product is designed to comply with the Waste Electricate ment (WEEE) Directive – 2002/96/EC. product is in compliance with California Proposition 65 (St ing Water and Toxic Enforcement Act of 1986). product is in compliance with the IEEE 1680 (EPEAT) stand epeat.net cs parts weighing over 25 grams used in the product are 501043. product contains 0.0% post-consumer recycled plastic (by product is 95.6% recycle-able when properly disposed of a	al and Electronic tate of California; Safe dard at the Gold level, see marked per ISO11469 y wt.)		
Packaging Materials	External:	PAPER/Corrugated	383 g		
	Internal:	PLASTIC/Polyethylene Expanded - EPE	90 g		
		PLASTIC/Polyethylene low density - LDPE	10 g		
		PLASTIC/Polypropylene - PP	5 g		
	The plastic packaging material contains at least 81.5% recycled content.				
	The corrugated paper packaging materials contains at least 80 % recycled content.				
Material Usage	This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):				
	 Certai Cadm Chlori Chlori Forma Halog Lead of 	in Azo Colorants in Brominated Flame Retardants – may not be used as fla	ame retardants in plastics		

	 Mercuric Oxide Batteries Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyls (PBBs) Polybrominated Biphenyl Ethers (PBBEs) Polybrominated Biphenyl Oxides (PBBOs) Polychlorinated Biphenyl (PCB) Polychlorinated Terphenyls (PCT) Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. Radioactive Substances Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging Usage	 HP follows these guidelines to decrease the environmental impact of product packaging: Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and Recycling	HP Inc.offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the HP Inc. web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM
HP Inc. Corporate Environmental Information	customers who integrate and re-sell HP equipment. For more information about HP's commitment to the environment: Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf



COUNTRY OF ORIGIN

China



Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
Memory	HP 4GB DDR4-2400 SODIMM (Core processors only)	Z4Y84AA
	HP 8GB DDR4-2400 SODIMM (Core processors only)	Z4Y85AA
	HP 16GB DDR4-2400 SODIMM (Core processors only)	Z4Y86AA
	HP 8GB DDR4-2133 EEC SODIMM (Xeon [®] processors only)	V1D58AA
	HP 16GB DDR4-2133 EEC SODIMM (Xeon [®] processors only)	V1D59AA
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Cases	HP Executive 15.6 Black Top Load	P6N18AA
	HP Business Case (up to 15.6")	H5M92AA
Docking	HP ZBook Dock with Thunderbolt™ 3	P5Q58AA
-	HP Executive Travel Hub	TOK29AA
	HP Travel Hub	TOK30AA
	HP 3005pr USB 3.0 Port Replicator w/ USB-C Adapter	Y4H06AA
	HP USB-Type C™ Elite Dock	X7W54AA
Input/Output -	HP Comfort Grip Wireless Mouse	H2L63AA
Mice	HP 3-Button Laser Mouse	H4B81AA#xxx
	HP Ultra Mobile Wireless Mouse	H6F25AA#xxx
	HP X4000 Bluetooth [®] Mouse	H3T50AA#xxx
	HP Slim Bluetooth [®] Mouse	F3J92AA#xxx
	HP Ultrathin Wireless Mouse	L9V78AA
	HP Wireless (Link-5) Keyboard	T6U20AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA#xxx
	HP Slim USB Keyboard and Mouse	T6T83AA
	HP Stereo 3.5mm Headset	T1A66AA
	HP Stereo USB Headset	T1A67AA
	HP 150W Slim Smart AC Adapter (4.5mm)	W2F74AA
Adapters	HP Wireless display adapter	J1V25AA#xxx
	HP USB-C to VGA Adapter	N9K76AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HDMI to DVI adapter	F5A28AA
	Thunderbolt™ 3 Dock Cable 1m	Z4P20AA
Collaboration	HP Conferencing Keyboard	K8P74AA#xxx
	HP UC Speaker Phone	K7V16AA
	HP UC Wired Headset	K7V17AA
	HP UC Wireless Mono Headset	W3K08AA
	HP UC Wireless Duo Headset	W3K09AA
	HP External USB Optical Drive	F2B56AA



Options and Accessories (sold separately and availability may vary by country)

Storage - Extern Storage	nal HP 500GB 7200rpm HDD HP 256GB TLC PCI-e 3x4 NVMe SSD (2280) HP 256GB M2 PCIe NVME SSD (2280) HP 512GB M2 PCIe NVME SSD (2280)	F3B97AA 1FU87AA V3K66AA V3K67AA
Security	HP UltraSlim Keyed Cable Lock HP Dual Head Cable Lock (Non-Master Key) HP Dual Head Cable Lock (Master Key) HP 15.6" Notebook PC Privacy Filter HP Essential Combination Lock HP Combination Lock HP Keyed Cable Lock 10mm	H4D73AA T1A64AA T1A65AA J7H71AA T0Y16AA T0Y15AA T0Y14AA T1A62AA

NOTE: External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.



Summary of Changes

Date of change:	Version History:		Description of change:	
April 21, 2017	From v1 to v2	Removed Integrated Bluetooth compatibility with 4.0, 4.1		
June 22, 2017	From v2 to v3	Added	Footnote for the Memory section	
July 31, 2017	From v3 to v4	Removed HP Touchpoint Manager from the Software section		
August 14, 2017	From v4 to v5	Changed	USB-C to TB1/TB2 cable replaced for the Thunderbolt 3 Dock Cable 1m in the Options and Accessories	



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